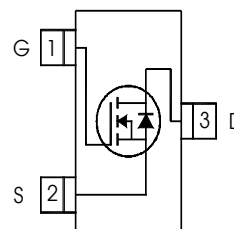
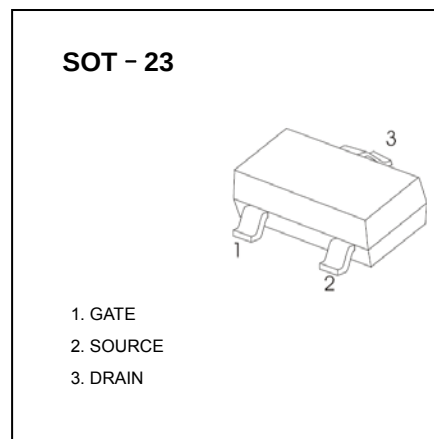


## Features

- $V_{DS} (V) = 30V$
- $R_{DS(ON)} < 250m\Omega$  ( $V_{GS} = 10V$ )
- $R_{DS(ON)} < 400m\Omega$  ( $V_{GS} = 4.5V$ )

## Description

- Generation VTechnology UltraLowOn- Resistance
- Low Profile (<1.1mm)
- Available in Tape and Reel
- Fast Switching
- Lead-Free
- RoHS CompliantHalogen-Free



## Absolute Maximum Ratings

|                          | Parameter                                | Max.         | Units |
|--------------------------|------------------------------------------|--------------|-------|
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 1.2          | A     |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 0.93         |       |
| $I_{DM}$                 | Pulsed Drain Current ①                   | 7.3          |       |
| $P_D @ T_A = 25^\circ C$ | Power Dissipation                        | 540          | mW    |
|                          | Linear Derating Factor                   | 4.3          | mW/°C |
| $V_{GS}$                 | Gate-to-Source Voltage                   | $\pm 20$     | V     |
| $E_{AS}$                 | Single Pulse Avalanche Energy ⑤          | 3.9          | mJ    |
| $dv/dt$                  | Peak diode Recovery $dv/dt$ ②            | 5.0          | V/ns  |
| $T_J, T_{STG}$           | Junction and Storage Temperature Range   | -55 to + 150 | °C    |

## Thermal Resistance

|                 | Parameter                     | Typ. | Max. | Units |
|-----------------|-------------------------------|------|------|-------|
| $R_{\theta JA}$ | Maximum Junction-to-Ambient ④ | —    | 230  | °C/W  |

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

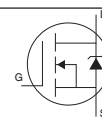
|                                 | Parameter                            | Min. | Typ.  | Max. | Units               | Conditions                                           |
|---------------------------------|--------------------------------------|------|-------|------|---------------------|------------------------------------------------------|
| $V_{(BR)DSS}$                   | Drain-to-Source Breakdown Voltage    | 30   | —     | —    | V                   | $V_{GS} = 0V, I_D = 250\mu A$                        |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient  | —    | 0.029 | —    | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}$ , $I_D = 1mA$        |
| $R_{DS(on)}$                    | Static Drain-to-Source On-Resistance | —    | —     | 250  | $m\Omega$           | $V_{GS} = 10V, I_D = 0.91A$ ③                        |
|                                 |                                      | —    | —     | 400  |                     | $V_{GS} = 4.5V, I_D = 0.46A$ ③                       |
| $V_{GS(th)}$                    | Gate Threshold Voltage               | 1.0  | —     | —    | V                   | $V_{DS} = V_{GS}, I_D = 250\mu A$                    |
| $g_{fs}$                        | Forward Transconductance             | 0.87 | —     | —    | S                   | $V_{DS} = 10V, I_D = 0.46A$                          |
| $I_{DSS}$                       | Drain-to-Source Leakage Current      | —    | —     | 1.0  | $\mu A$             | $V_{DS} = 24V, V_{GS} = 0V$                          |
|                                 |                                      | —    | —     | 25   |                     | $V_{DS} = 24V, V_{GS} = 0V, T_J = 125^\circ\text{C}$ |
| $I_{GSS}$                       | Gate-to-Source Forward Leakage       | —    | —     | -100 | nA                  | $V_{GS} = -20V$                                      |
|                                 | Gate-to-Source Reverse Leakage       | —    | —     | 100  |                     | $V_{GS} = 20V$                                       |
| $Q_g$                           | Total Gate Charge                    | —    | 3.3   | 5.0  | nC                  | $I_n = 0.91A$                                        |
| $Q_{gs}$                        | Gate-to-Source Charge                | —    | 0.48  | 0.72 |                     | $V_{DS} = 24V$                                       |
| $Q_{gd}$                        | Gate-to-Drain ("Miller") Charge      | —    | 1.1   | 1.7  |                     | $V_{GS} = 10V$ , See Fig. 6 and 9 ③                  |
| $t_{d(on)}$                     | Turn-On Delay Time                   | —    | 3.9   | —    | ns                  | $V_{DD} = 15V$                                       |
| $t_r$                           | Rise Time                            | —    | 4.0   | —    |                     | $I_n = 0.91A$                                        |
| $t_{d(off)}$                    | Turn-Off Delay Time                  | —    | 9.0   | —    |                     | $R_G = 6.2\Omega$                                    |
| $t_f$                           | Fall Time                            | —    | 1.7   | —    |                     | $R_D = 16\Omega$ , See Fig. 10 ③                     |
| $C_{iss}$                       | Input Capacitance                    | —    | 85    | —    | pF                  | $V_{DS} = 0V$                                        |
| $C_{oss}$                       | Output Capacitance                   | —    | 34    | —    |                     | $V_{DS} = 25V$                                       |
| $C_{rss}$                       | Reverse Transfer Capacitance         | —    | 15    | —    |                     | $f = 1.0MHz$ , See Fig. 5                            |

**Source-Drain Ratings and Characteristics**

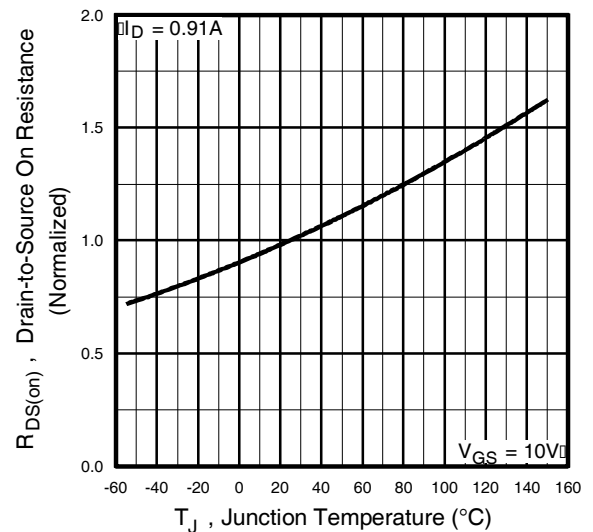
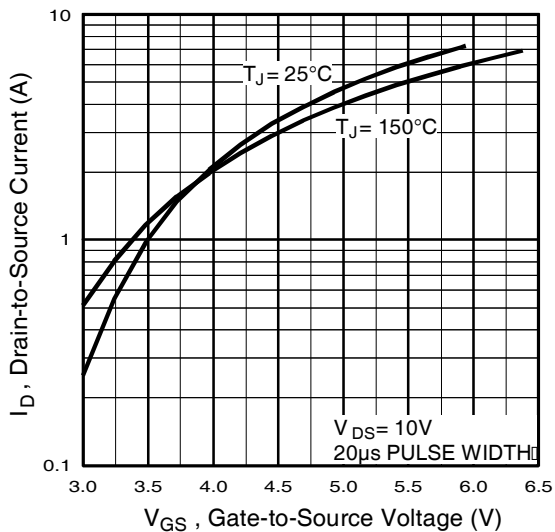
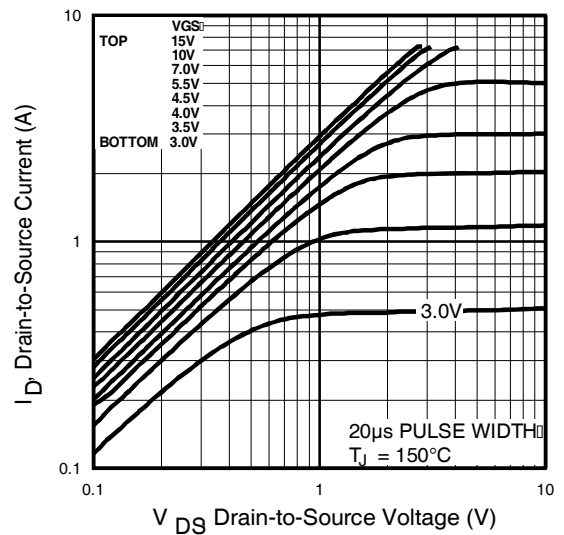
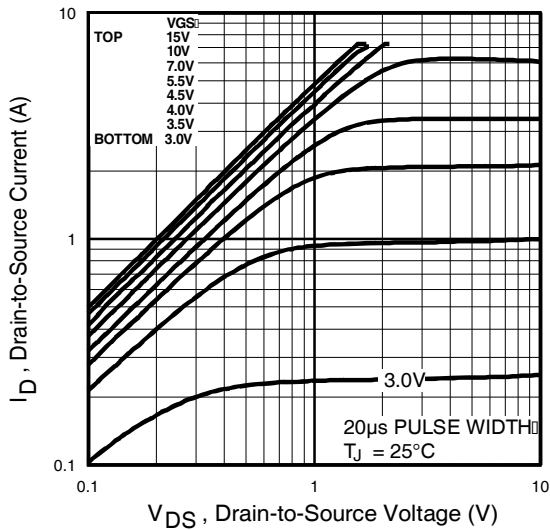
|          | Parameter                                 | Min. | Typ. | Max. | Units | Conditions                                                              |
|----------|-------------------------------------------|------|------|------|-------|-------------------------------------------------------------------------|
| $I_S$    | Continuous Source Current<br>(Body Diode) | —    | —    | 0.54 | A     | MOSFET symbol<br>showing the<br>integral reverse<br>p-n junction diode. |
| $I_{SM}$ | Pulsed Source Current<br>(Body Diode) ①   | —    | —    | 7.3  |       |                                                                         |
| $V_{SD}$ | Diode Forward Voltage                     | —    | —    | 1.2  | V     | $T_J = 25^\circ\text{C}, I_S = 0.91A, V_{GS} = 0V$ ③                    |
| $t_{rr}$ | Reverse Recovery Time                     | —    | 26   | 40   | ns    | $T_J = 25^\circ\text{C}, I_F = 0.91A$                                   |
| $Q_{rr}$ | Reverse Recovery Charge                   | —    | 22   | 32   | nC    | $di/dt = 100A/\mu s$ ③                                                  |

**Notes:**

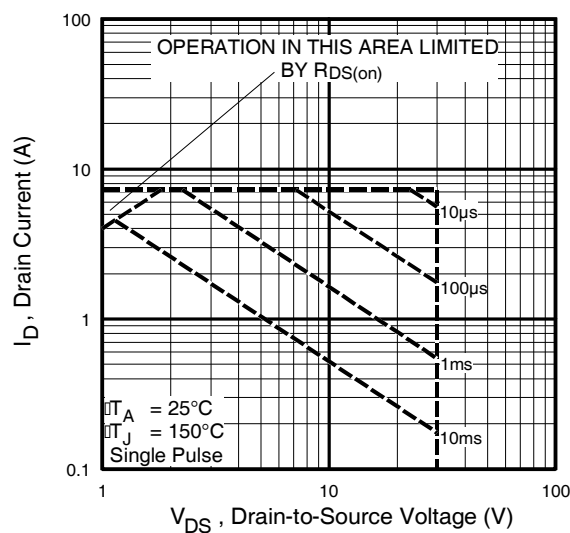
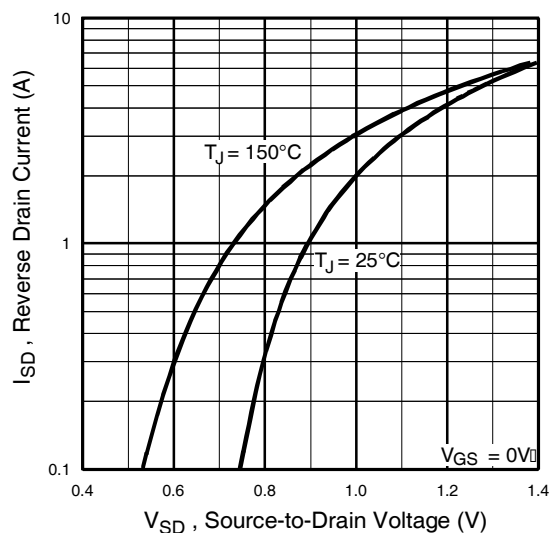
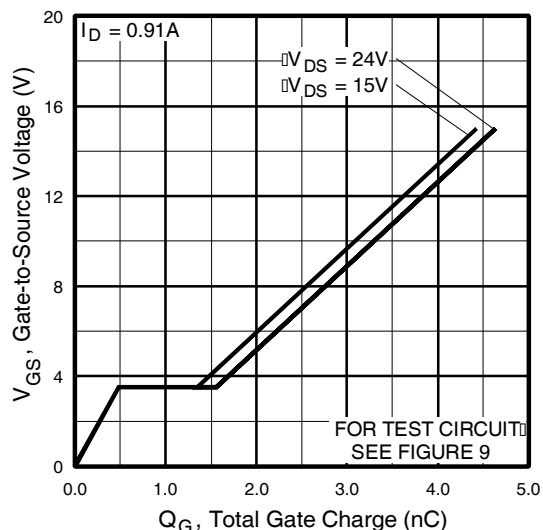
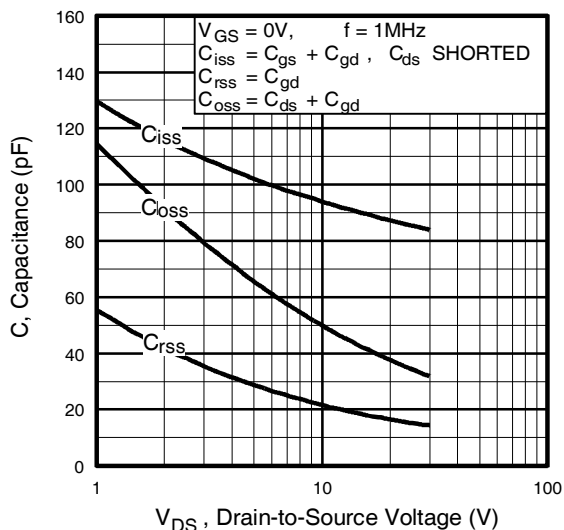
- ① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )
- ②  $I_{SD} \leq 0.91A$ ,  $di/dt \leq 120A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 150^\circ\text{C}$
- ③ Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ .
- ④ Surface mounted on FR-4 board,  $t \leq 5sec$ .
- ⑤ Limited by  $T_{Jmax}$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 9.4mH$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 0.9A$ .

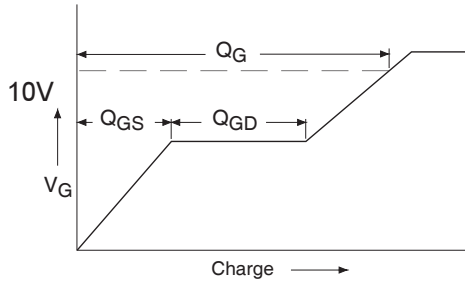


## Typical Electrical Characteristics

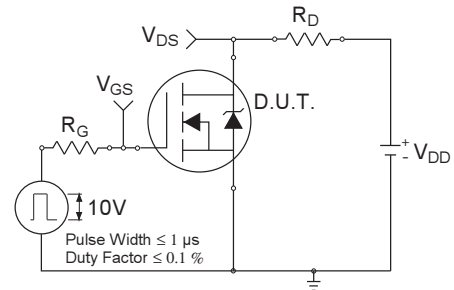


## Typical Electrical Characteristics

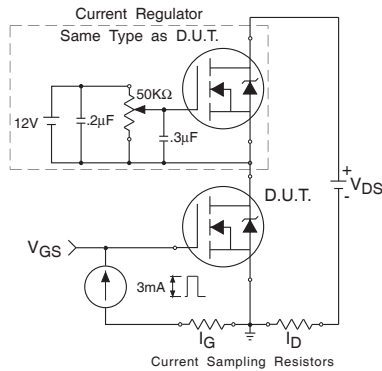




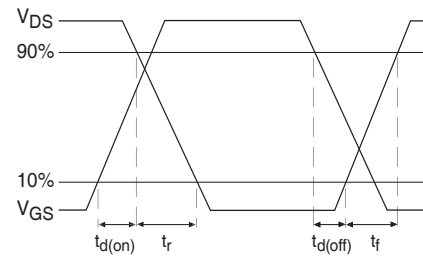
**Fig 9a. Basic Gate Charge Waveform**



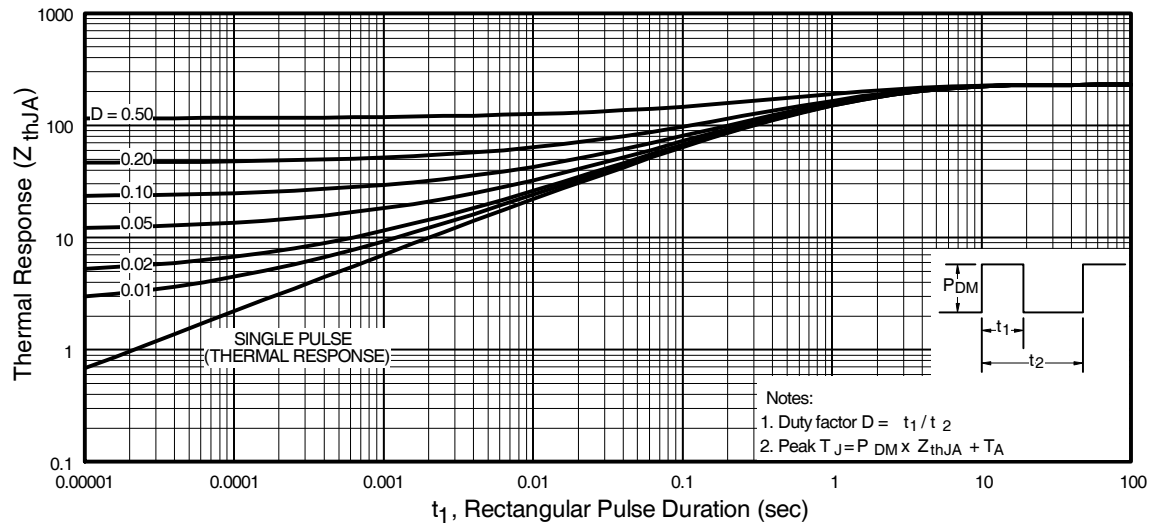
**Fig 10a. Switching Time Test Circuit**



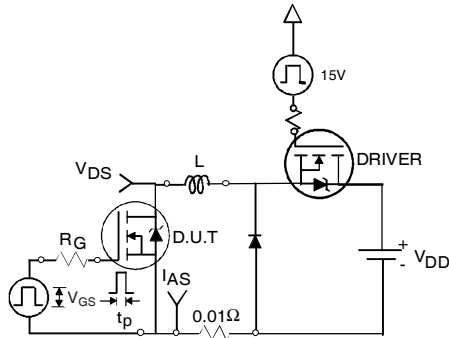
**Fig 9b. Gate Charge Test Circuit**



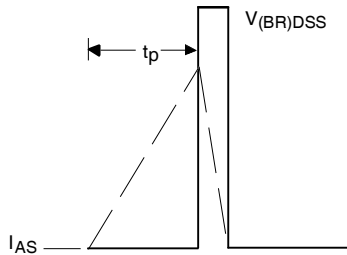
**Fig 10b. Switching Time Waveforms**



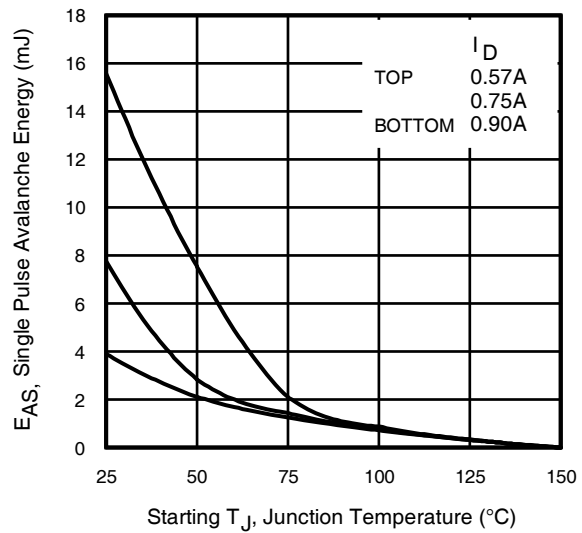
**Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient**



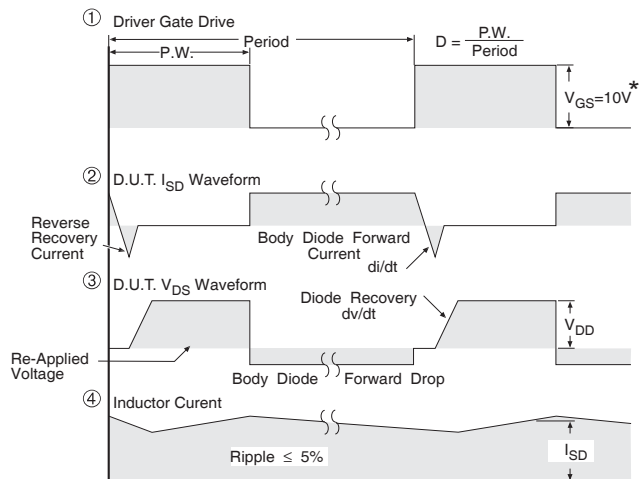
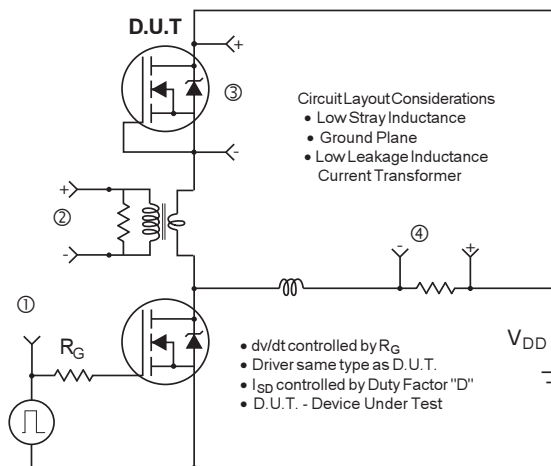
**Fig 12a.** Unclamped Inductive Test Circuit



**Fig 12b.** Unclamped Inductive Waveforms



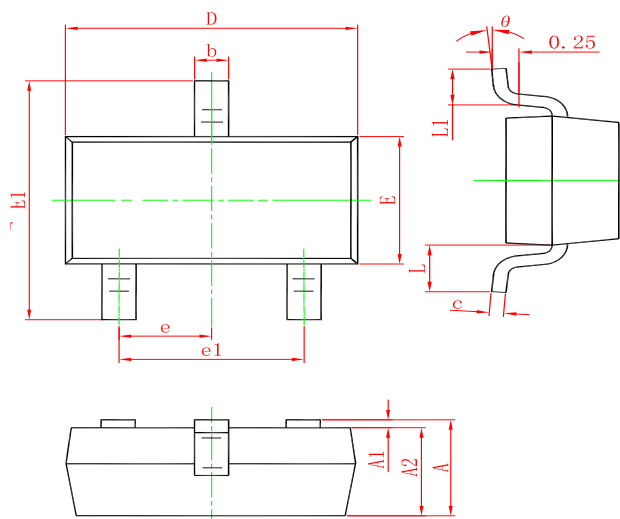
**Fig 12c.** Maximum Avalanche Energy vs. Drain Current



\*  $V_{GS} = 5V$  for Logic Level Devices

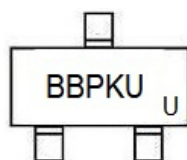
**Fig 13.** Peak Diode Recovery  $dv/dt$  Test Circuit for N-Channel HEXFET<sup>®</sup> Power MOSFETs

## SOT-23 PACKAGE OUTLINE DIMENSIONS



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.150 | 0.035                | 0.045 |
| A1     | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2     | 0.900                     | 1.050 | 0.035                | 0.041 |
| b      | 0.300                     | 0.500 | 0.012                | 0.020 |
| c      | 0.080                     | 0.150 | 0.003                | 0.006 |
| D      | 2.800                     | 3.000 | 0.110                | 0.118 |
| E      | 1.200                     | 1.400 | 0.047                | 0.055 |
| E1     | 2.250                     | 2.550 | 0.089                | 0.100 |
| e      | 0.950 TYP.                |       | 0.037 TYP.           |       |
| e1     | 1.800                     | 2.000 | 0.071                | 0.079 |
| L      | 0.550 REF.                |       | 0.022 REF.           |       |
| L1     | 0.300                     | 0.500 | 0.012                | 0.020 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

## Marking



## Ordering information

| Order code      | Package | Baseqty | Deliverymode  |
|-----------------|---------|---------|---------------|
| UMW IRLML2803TR | SOT-23  | 3000    | Tape and reel |